SPECIFICATIONS (Measurements @ 25°C, ±2g full scale range, acceleration = 0 g unless otherwise noted; VDD=1.8V unless otherwise specified)

Table 1: Parameter specification

PARAMETER	Conditions	MIN	TYP	MAX	UNITS
Full Scale Ranges (FSR) [1]	FSR[1:0] set to 0	-2		+2	g
	FSR[1:0] set to 1	-4		+4	
	FSR[1:0] set to 2	-8		+8	
Nonlinearity	Best fit straight line		±0.5		% FSR
Alignment Error [2]			±0.5		degree
Cross Axis Sensitivity [3]			±2.0		%
Sensitivity	±2g FSR		1024		LSB/g
	±4g FSR		512		
	±8g FSR		256		
Sensitivity Accuracy			±3		%
Sensitivity TC	Δ from 25°C		±0.025		%/°C
Zero *g* Offset Bias Level [4]			+80		mg
Zero *g* Offset TC [4] (Δ from 25°C)			±0.8		mg/°C
Noise Density	X and Y-axis		1		mg/√Hz
	Z-axis		2		
Self-test Output [5]	X and Y-axis	-384	-768		LSB
Output Data Rates (ODR)			100		Hz
Operating Voltage (VDD)		1.62	1.8	3.6	V
I^2C Bus Voltage (VIO)		1.2		VDD	V
Temperature Sensor Sensitivity			0.586		°C/LSB
Temperature Sensor Offset			0		LSB
Turn-on Time [6]			250	400	ms
Supply Current			1.3		mA
Power Down Current			0.8	1.0	μA
Operating Temperature Range		-40		+85	°C

Note:[1]: Guaranteed by measurement of initial offset and sensitivity
[2]: Alignment error is specified as the angle between the true and indicated axis of sensitivity
[3]: Relative contribution between any two of the three axis
[4]: With MEMSIC's software driver (included)
[5]: Self-Test should operate in 8g mode
[6]: Output settled to within +/-20 mg of the final value after existing power down mode

ABSOLUTE MAXIMUM RATINGS*

Supply Voltage (VDD)	-0.5 V to +5.0V
Storage Temperature	-40°C to +150°C
Acceleration	200,000g
ESD	2kV (HBM)

* Exposure to absolute maximum rating conditions for extended periods may affect device reliability. This is a stress rating only; the functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

ORDERING GUIDE

MXC6655XA

Package type:

Code	Type
A	LGA package

Performance Grade:

Code	Temp	Resolution
X	-40 ~ 85°C	12-bit

Address code: 0 ~ 7

Number	7-bit I²C Address
5	15H

Figure 2: Ordering guide

* Parts are shipped in tape and reel packaging.

PIN DESCRIPTION

Pin	Name	Description
1	NC	No Connection
2	SDA	Serial Data Line for I²C bus
3	NC	No Connection
4	NC	No Connection
5	INT	Interrupt Output
6	NC	No Connection
7	VDD	1.62 V to 3.6 V
8	NC	No Connection
9	GND	Connected to Ground
10	NC	No Connection
11	NC	No Connection
12	SCL	Serial Clock Line for I²C bus

Caution: Electro Static Discharge (ESD) sensitive device.

PACKAGE ILLUSTRATION

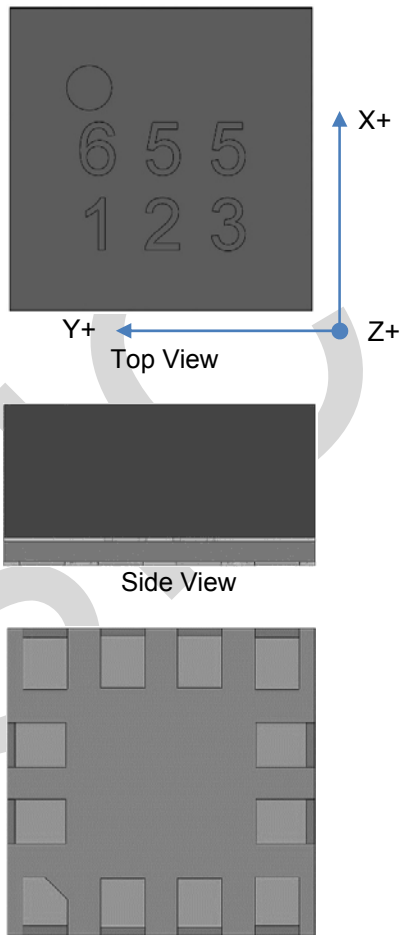

Figure 3: Package illustration

THEORY OF OPERATION

This device is a complete three-axis acceleration measurement system fabricated using 0.18um CMOS process. The device operation is based on MEMSIC's proprietary sensor design gas convection.

A heat source, surrounded by thermopiles in the silicon chip, is suspended across a cavity. This heat source creates a field of heated gas around it, commonly referred as hot air bubble. The thermopiles capable of detecting changes in the temperature field around the heater. Applied acceleration disturbs the temperature profile. The temperature, and hence voltage output of thermopiles will then be different. The differential voltage at the thermopile outputs is directly proportional to the acceleration.

A signal path on the MXC6655XA measures accelerations at three directions and temperature sequentially.

For more details, visit the MEMSIC website at www.MEMSIC.com for a picture/graphic description of the free convection heat transfer principle.

PIN DESCRIPTIONS

SDA – I²C serial data line that operates in FAST mode.

INT – Interrupt output. The logic level on this pin reflects the state of the INT bit in the STATUS register. INT is set when the orientation differs from the last orientation read by the processor or an X/Y shake event is detected. INT needs to be pulled up to VIO. INT output is active low, and is cleared upon register INT_CLRx was written 1 by the I²C master. Refer to the description of user register 0x01 in the "MXC6655XA USER REGISTERS" section.

VDD – Supply input for the circuits and the sensor heater in the accelerometer. The DC voltage should be between 1.62 and 3.6 volts.

GND – Accelerometer ground pin.

NC – Should be left open.

SCL – I²C serial clock line that operates in FAST mode.

HARDWARE DESIGN CONSIDERATION

1. R1, R2, and R3 are pull-up resistors. The value can be determined by user according to the requirement of the host device; recommend using 2.7Kohm.
2. If INT is not used, it can be kept disconnected.
3. It is necessary to keep VDD voltage clean for best noise performance. A low-ESR bypass cap is required and recommended value is 1~4.7μF. It should be placed close to the device as much as possible.

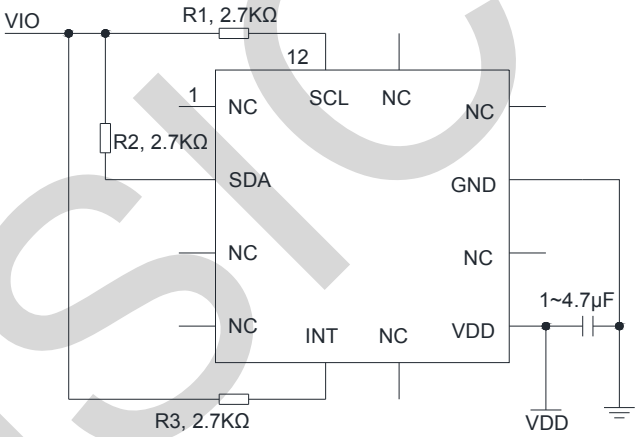

Figure 4: Connection diagram

LAND PATTERN

1. The device routing should be symmetric.
2. Recommended land pattern of PCB is shown in Figure 5.
3. Thickness of stencil should be 0.08mm ~ 0.1mm.

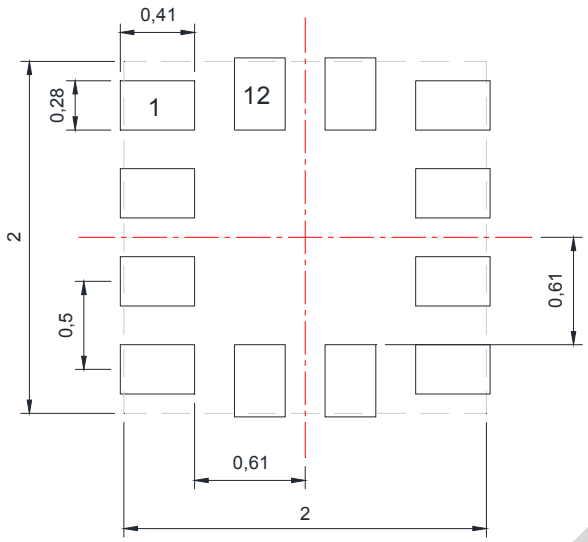

Figure 5: Recommended land pattern (unit: mm)

END of LIFE DISPOSAL

End-of-life products should be disposed/ recycled properly in accordance to national and local regulation.

SOLDER REFLOW PROFILE

1. Reflow is limited by 2 times. Second reflow should be applied after device has cooled down to room temperature (25℃).
2. Recommended reflow profile for Pb free process is shown in Figure 6. The time duration of peak temperature (260℃) should be limited to 10 seconds.
3. Type 4 solder paste is recommended for a better SMT quality.

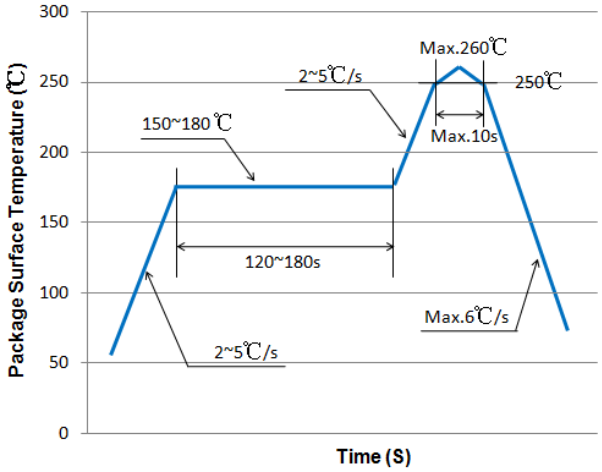

Figure 6: Recommended solder reflow profile

MANUAL SOLDERING

1. When soldering/repairing MXC6655XA manually via solder iron or heater gun, the temperature on the device should not exceed 260℃ and the time should be limited to 10 seconds.
2. Avoid bending or torqueing the PCB after the sensor is assembled.

DIGITAL INTERFACE

Table 3: Digital interface, I/V

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNITS
V_{IL}	Logic Input Low Level			0.3*VIO	V
V_{IH}	Logic Input High Level		0.7*VIO		V
V_{hys}	Hysteresis of Schmitt input		0.1		V
V_{OL}	Logic Output Low Level			0.2*VIO	V
V_{OH}	Logic Output High Level		0.8*VIO		V
I_i	Input Leakage Current	$0.1V_{DD}<V_{in}<0.9V_{DD}$	-10	10	μA

Table 4: Digital interface, timing

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
f_{SCL}	SCL Clock Frequency		0		400	kHz
$t_{HD;STA}$	START Hold Time		0.6			μS
$t_{SU;STA}$	START Setup Time		0.6			μS
t_{LOW}	LOW period of SCL		1.3			μS
t_{HIGH}	HIGH period of SCL		0.6			μS
$t_{HD;DAT}$	Data Hold Time		0		0.9	μS
$t_{SU;DAT}$	Data Setup Time		0.1			μS
t_r	Rise Time	From V_{IL} toV_{IH}			0.3	μS
t_f	Fall Time	From V_{IH} toV_{IL}			0.3	μS
t_{BUF}	Bus Free Time Between STOP and START		1.3			μS
$t_{SU;STO}$	STOP Setup Time		0.6			μS

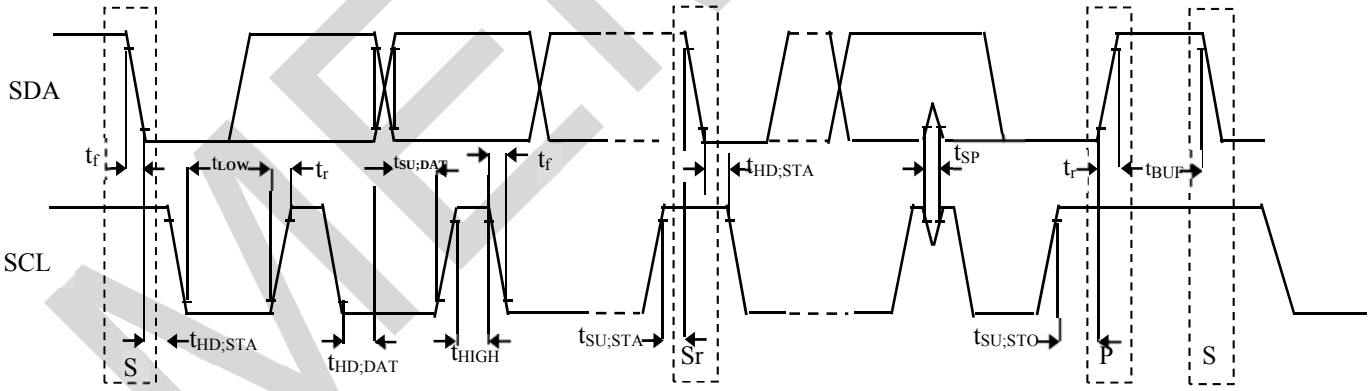

Figure 7: I²C timing

Note: Both SCL and SDA should not be low for longer than 10ms

I²C INTERFACE DESCRIPTION

A slave mode I²C interface, capable of operating in standard or fast mode, is implemented on the MXC6655XA. The interface uses a serial data line (SDA) and a serial clock line (SCL) to achieve bi-directional communication between master and slave devices. A master (typically a microprocessor) initiates all data transfers to and from the device, and generates the SCL clock that synchronizes the data transfer. The SDA pin on the MXC6655XA operates both as an input and an open drain output. Since the MXC6655XA only operates as a slave device, the SCL pin is always an input. There are external pull-up resistors on the I²C bus lines. Devices that drive the I²C bus lines do so through open-drain n-channel driver transistors, creating a wired NOR type arrangement.

Data on SDA is only allowed to change when SCL is low. A high to low transition on SDA when SCL is high is indicative of a START condition, whereas a low to high transition on SDA when SCL is high is indicative of a STOP condition**.** When the interface is not busy, both SCL and SDA are high. A data transmission is initiated by the master pulling SDA low while SCL is high, generating a START condition. The data transmission occurs serially in 8 bit bytes, with the MSB transmitted first. During each byte of transmitted data, the master will generate 9 clock pulses. The first 8 clock pulses are used to clock the data, the 9th clock pulse is for the acknowledge bit. After the 8 bits of data are clocked in, the transmitting device releases SDA, and the receiving device pulls it down so that it is stable low during the entire 9th clock pulse. By doing this, the receiving device "acknowledges" that it has received the transmitted byte. If the slave receiver does not generate an acknowledge, then the master device can generate a STOP condition and abort the transfer. If the master is the receiver in a data transfer, then it must signal the end of data to the slave by not generating an acknowledge on the last byte that was clocked out of the slave. The slave must release SDA to allow the master to generate a STOP or repeated START condition.

The master initiates a data transfer by generating a START condition. After a data transmission is complete, the master may terminate the data transfer by generating a STOP condition. The bus is considered to be free again a certain time after the STOP condition. Alternatively, the master can keep the bus busy by generating a repeated START condition instead of a STOP condition. This repeated START condition is functionally identical to a START condition that follows a STOP. Each device that sits on the I²C bus has a unique 7-bit address.

The first byte transmitted by the master following a START is used to address the slave device. The first 7 bits contain the address of the slave device, and the 8th bit is the R/W* bit (read = 1, write = 0; the asterisk indicates active low, and is used instead of a bar). If the transmitted address matches up to that of the MXC6655XA, then the MXC6655XA will acknowledge receipt of the address, and prepare to receive or send data.

If the master is writing to the MXC6655XA, then the next byte that the MXC6655XA receives, following the address byte, is loaded into the address counter internal to the MXC6655XA. The contents of the address counter indicate which register on the MXC6655XA is being accessed. If the master now wants to write data to the MXC6655XA, it just continues to send 8-bit bytes. Each byte of data is latched into the register on the MXC6655XA that the address counter points to. The address counter is incremented after the transmission of each byte.

If the master wants to read data from the MXC6655XA, it first needs to write the address of the register it wants to begin reading data from to the MXC6655XA address counter. It does this by generating a START, followed by the address byte containing the MXC6655XA address, with R/W* = 0. The next transmitted byte is then loaded into the MXC6655XA address counter. Then, the master repeats the START condition and re-transmits the MXC6655XA address, but this time with the R/W* bit set to 1. During the next transmission period, a byte of data from the MXC6655XA register that is addressed by the contents of the address counter will be transmitted from the MXC6655XA to the master. As in the case of the master writing to the MXC6655XA, the contents of the address counter will be incremented after the transmission of each byte. The protocol for multiple byte reads and writes between a master and a slave device is depicted as follows.

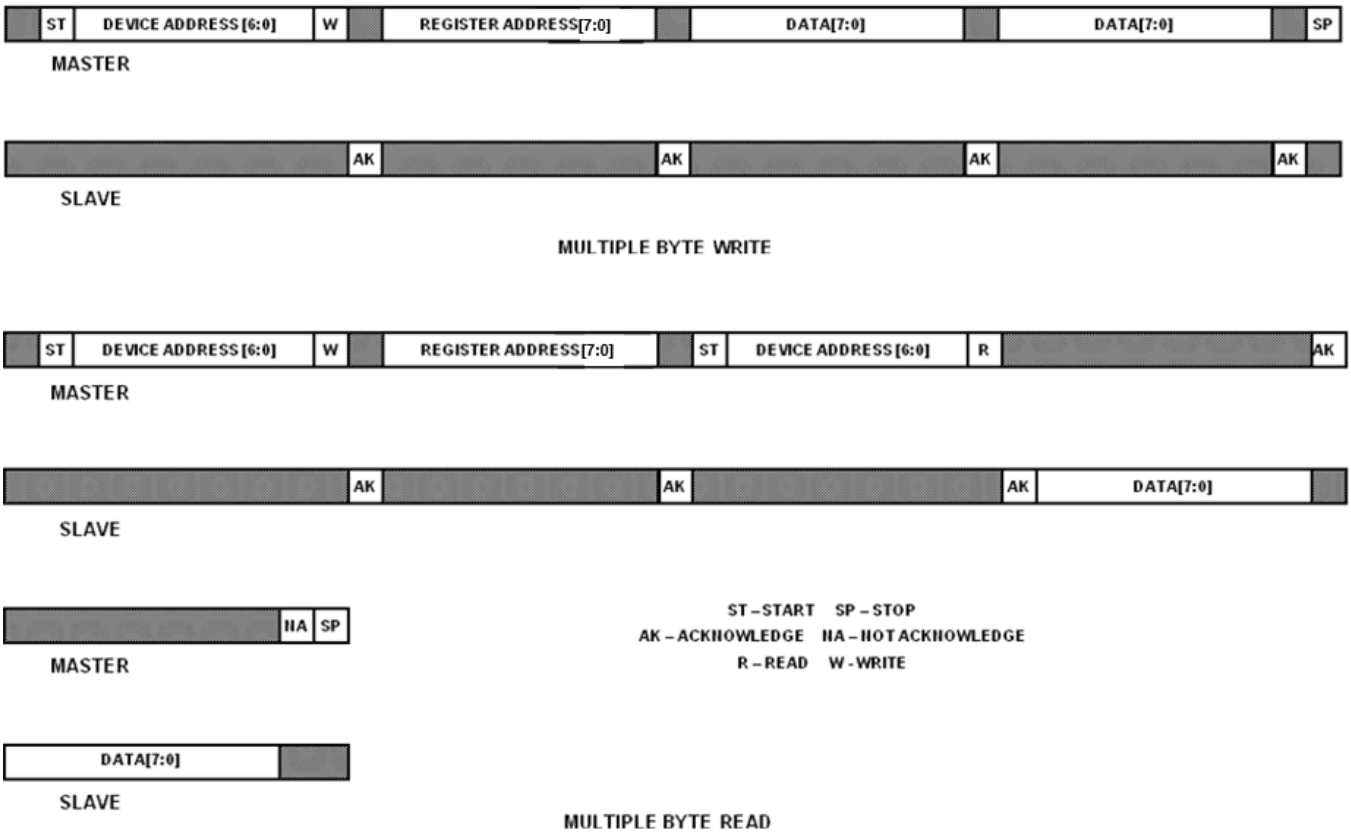

Figure 8: I²C protocol

MXC6655XA I²C interface allows I²C interface voltage VIO to be lower than the supply voltage VDD. VIO can be as low as 1.2 Volts. In order to achieve reliable operation, avoid the situation when both SCL and SDA pins are low for longer than 10ms. Please contact MEMSIC if you plan on using I²C interface voltage VIO greater than VDD.

MXC6655XA USER REGISTERS

MXC6655XA has 16 8-bit USER registers with addresses of 0x00 ~ 0x0F.

0x00: INT_SRC0 - Shake & change in orientation interrupt sources (read only)

Table 5: Shake & change in orientation interrupt sources, register 0x00 (read only)

D7	D6	D5	D4	D3	D2	D1	D0
CHORZ	CHORXY	0	0	SHYM	SHYP	SHXM	SHXP

0x00: INT_CLR0 - Shake & change in orientation interrupt clear (write only)

Table 6: Shake & change in orientation interrupt clear, register 0x00 (write only)

D7	D6	D5	D4	D3	D2	D1	D0
ORZC	ORXYC	-	-	SHYMC	SHYPC	SHXMC	SHXPC

0x01: INT_SRC1 - Data ready interrupt sources, tilt & orientation status (read only)

Table 7: Data ready interrupt sources, tilt & orientation, register 0x01 (read only)

D7	D6	D5	D4	D3	D2	D1	D0
TILT	ORZ	ORXY[1]	ORXY[0]	0	0	0	DRDY

0x01: INT_CLR1 - Data ready, tilt & data ready interrupt clear (write only)

Table 8: Data ready, tilt & data ready interrupt clear, register 0x01 (write only)

D7	D6	D5	D4	D3	D2	D1	D0
-	-	-	SW_RST	-	-	-	DRDYC

The INT_SRCx and INT_CLRx are read-only and write-only registers, respectively, sharing the same respective I^2C addresses (0x00, 0x01). The INT_SRCx registers contain information indicating the source of interrupts produced on the INT output pin. When an event occurs which generates an interrupt output, the corresponding bit in the INT_SRCx register is set to 1. The I^2C master can poll the INT_SRCx registers to determine the cause of the interrupt, then read the appropriate registers to determine status, read data, and perform any necessary actions to service the interrupt. When interrupt servicing for that interrupt source is completed, the master writes a 1 into the corresponding bit location of the INT_CLRx register. MXC6655XA then clears that bit of the INT_SRCx register, then automatically clears the same bit in the INT_CLRx register. MXC6655XA does not clear any INT_SRCx register bits whose corresponding bit in the INT_CLRx register is set to 0.

The SHXP, SHXM, SHYP, or SHYM, bit in the INT_SRC0 register is set to 1 whenever a shake event is detected in the +X, −X, +Y, or −Y direction, respectively. If a shake event is detected in any axis and the appropriate bit in the INT_SRC0 register is set, any further detection of shake events in that axis is disabled until the shake bit for that axis is cleared by writing 1 to the corresponding bit in the INT_CLR0 register. Refer to the description of the DETECTION register for more information on shake detection.

The CHORXY bit in the INT_SRC0 register is set to 1 whenever a change in the X/Y plane orientation is detected. The CHORZ bit in the INT_SRC0 register is set to 1 whenever a change in the Z axis orientation is detected. Refer to the description of the DETECTION register for more information on orientation detection.

The ORXY[1:0] and ORZ[1:0] bits in INT_SRC1 indicate the orientation of MXC6655XA. ORXY indicates orientation of the XY plane, and ORZ indicates direction of the Z axis. Mapping of the orientation bits is as follows:

Table 9: X and Y Orientation

ORXY[1]	ORXY[0]	Orientation
0	0	+X (X=+1g)
0	1	+Y (Y=+1g)
1	0	−X (X=−1g)
1	1	−Y (Y=−1g)

Orientation bits are determined by monitoring the magnitudes and signs of the X, Y, and Z acceleration outputs. The ORXY[1:0] bits are indicative of current orientation only if the off-axis tilt angle (angle between the XY plane and earth gravity vector) is small enough that there is sufficient acceleration amplitude on the X or Y axis to determine a valid XY orientation. For ORXY[1:0] to be updated, the larger of the X and Y axis acceleration magnitudes (a_x, a_y) must be greater than 0.375g. If this is not the case, the ORXY[1:0] bits retain their last values determined when there was sufficient acceleration amplitude to make a valid orientation decision.

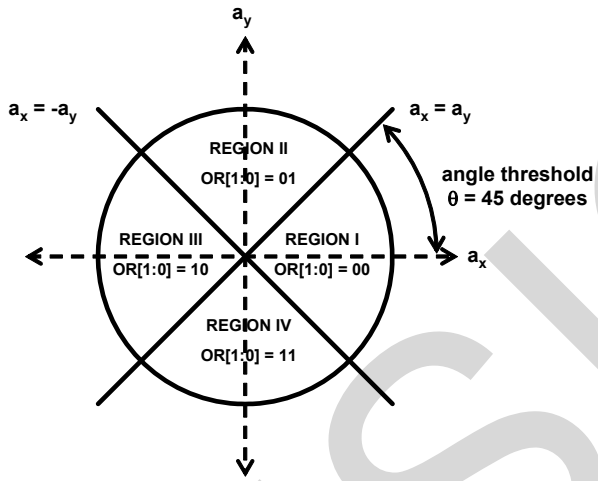

Figure 9: Orientation map

Table 10: Z Orientation

TILT/ORZ[1]	ORZ[0]	Orientation
0	0	positive Z, tilt not detected
0	1	negative Z, tilt not detected
1	0	positive Z, tilt detected
1	1	negative Z, tilt detected

The ORZ[1:0] bits indicate the Z axis orientation as shown in the table above. The vertical/horizontal Z axis orientation is determined by the same criteria used to determine the XY-plane off-axis tilt angle. When the XY plane has a sufficiently small off-axis tilt angle, XY orientation detection is valid (and continues to be updated), and the Z axis is detected as horizontal. ORZ[1] is also the bit for this TILT condition. When off-axis tilt angle exceeds the threshold discussed above, the Z axis is detected as either vertical up or vertical down, depending on the sign of the Z axis acceleration output.

To prevent flickering of the ORXY[1:0] and ORZ[1:0] bits near the orientation region boundaries, a valid measurement of the new orientation must be measured a consecutive number of times determined by the setting of the ORC[1:0] (orientation count) bits in the DETECTION register. This provides a low-pass filtering and hysteresis effect which prevents the orientation bits from rapidly changing.

The DRDY (data ready) bit in the INT_SRC1 register is set to 1 whenever a new measurement has been made, and new outputs are ready in the XOUT, YOUT, ZOUT and TOUT registers.

The TILT/ORZ[1] bit indicates the part is tilted too much in the X/Y plane, and the X/Y signal is too small to reliably determine orientation. In this case ORXY[1:0] updates are disabled, the orientation remains at its last value.

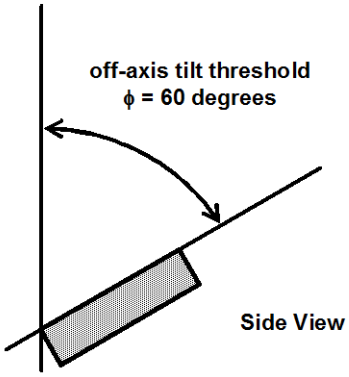

Figure 10: Off-axis tilt

Writing a 1 to the SW_RST bit will reset the part as if it had just powered up. The reset remains active as long as the current I²C transfer is active. Accordingly, the I²C logic itself is excluded, or it would not properly acknowledge (ACK) the current command.

0x02: STATUS - Instantaneous orientation status (read only)

Table 11: Instantaneous orientation status, register 0x02 (read only)

D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	ORD	ORIZ[1]	ORIZ[0]	ORIXY[1]	ORIXY[0]

The ORIXY[1:0] and ORIZ[1:0] bits are identical to ORXY[1:0] and ORZ[1:0], respectively, except that they are not subject to the same low-pass filtering as ORXY[1:0] and ORZ[1:0]. ORIXY[1:0] and ORIZ[1:0] are not normally used in the end application but are provided as outputs for information purposes.

ORD indicates that the OTP memory has been read. If a controller were to read a device before the OTP memory was read in, the results would be inaccurate, since the calibration data has not yet been loaded. Afterward, this bit will be 1 and cannot be reset by the user.

0x03: XOUT Upper - X-axis acceleration output MSB

Table 12: XOUT Upper, register 0x03

D7	D6	D5	D4	D3	D2	D1	D0
XOUT[11]	XOUT[10]	XOUT[9]	XOUT[8]	XOUT[7]	XOUT[6]	XOUT[5]	XOUT[4]

0x04: XOUT Lower - X-axis acceleration output LSB

Table 13: XOUT Lower, register 0x04

D7	D6	D5	D4	D3	D2	D1	D0
XOUT[3]	XOUT[2]	XOUT[1]	XOUT[0]	0	0	0	0

XOUT[11:0] is the 12-bit X-axis acceleration output. The output is in 2's complement format, with a range of −2048 to +2047.

0x05: YOUT Upper - Y-axis acceleration output MSB

Table 14: YOUT Upper, register 0x05

D7	D6	D5	D4	D3	D2	D1	D0
YOUT[11]	YOUT[10]	YOUT[9]	YOUT[8]	YOUT[7]	YOUT[6]	YOUT[5]	YOUT[4]

0x06: YOUT Lower - Y-axis acceleration output LSB

Table 15: YOUT Lower, register 0x06

D7	D6	D5	D4	D3	D2	D1	D0
YOUT[3]	YOUT[2]	YOUT[1]	YOUT[0]	0	0	0	0

YOUT[11:0] is the 12-bit y-axis acceleration output. Format is identical to the XOUT[11:0] output.

0x07: ZOUT Upper - Z-axis acceleration output MSB

Table 16: ZOUT Upper, register 0x07

D7	D6	D5	D4	D3	D2	D1	D0
ZOUT[11]	ZOUT[10]	ZOUT[9]	ZOUT[8]	ZOUT[7]	ZOUT[6]	ZOUT[5]	ZOUT[4]

0x08: ZOUT Lower - Z-axis acceleration output LSB

Table 17: ZOUT Lower, register 0x08

D7	D6	D5	D4	D3	D2	D1	D0
ZOUT[3]	ZOUT[2]	ZOUT[1]	ZOUT[0]	0	0	0	0

ZOUT[11:0] is the 12-bit z-axis acceleration output. Format is identical to the XOUT[7:0] output.

0x09: TOUT - Temperature output

Table 18: TOUT, register 0x09

D7	D6	D5	D4	D3	D2	D1	D0
TOUT[7]	TOUT[6]	TOUT[5]	TOUT[4]	TOUT[3]	TOUT[2]	TOUT[1]	TOUT[0]

MXC6655XA contains an on-chip temperature sensor whose output can be read through the I²C interface. The output is in 2's complement format. The nominal value of TOUT[7:0] is 0 at a temperature of 25°C, and the sensitivity of the output is approximately 0.586°C/LSB.

0x0A: INT_MASK0 - Shake & orientation detection interrupt mask (write only)

Table 19: Shake & orientation detection interrupt mask, register 0x0A (write only)

D7	D6	D5	D4	D3	D2	D1	D0
ORZE	ORXYE	-	-	SHYME	SHYPE	SHXME	SHXPE

0x0B: INT_MASK1 - Data ready, tilt & data ready interrupt mask (write only)

Table 20: Data ready interrupt mask, register 0x0B (write only)

D7	D6	D5	D4	D3	D2	D1	D0
TC	-	0	0	-	-	-	DRDYE

The INT_MASKx registers are used to selectively enable or disable individual interrupts. When any bit in the INT_MASKx register is set to 1, the corresponding interrupt in the INT_SRCx register is enabled, allowing the event which set that bit in the INT_SRCx register to produce an interrupt signal on the INT output pin. The INT output is the logical NOR of all bits in the INT_SRC0 register and bits D2-D0 in the INT_SRC1 register which are enabled by the corresponding bits in the INT_MASKx register.

TC is a bit used to disable temperature compensation. It is necessary for proper Self-Test operation.

Note: The INT output is an active-low, open drain output. An external pull-up resistor is required on the INT pin when the INT output is used.

The bits in the INT_SRCx registers are set when the events corresponding to those bits occur, regardless of the state of the corresponding bits in the INT_MASKx register. This allows the I²C master to poll for occurrence of events, rather than to respond to interrupts created by the same events.

0x0C: DETECTION - Orientation and shake detection parameters (read/write)

Table 21: Orientation and shake detection parameters, register 0x0C (read/write)

D7	D6	D5	D4	D3	D2	D1	D0
SHM	SHTH[2]	SHTH[1]	SHTH[0]	SHC[1]	SHC[0]	ORC[1]	ORC[0]

ORC[1:0] sets the orientation count, which is the number of consecutive valid new orientation readings that must be made before a new orientation value is written into bits OR[1:0] in the STATUS register. The nominal rate at which readings are taken is 100 Hz. The number of consecutive valid orientation measurements required to effect a "long-term" orientation change is set by ORC[1:0] as follows: 00 – 16 readings, 01 – 32 readings, 10 – 64 readings, 11 – 128 readings.

SHC[1:0] sets the X/Y shake count, which determines the number of readings allowed between the first shake event (acceleration exceeding the threshold set by SHTH[2:0]) and the second shake event (acceleration breaking the threshold with opposite sign, if SHM = 0, or just reversing sign, if SHM = 1). The number of readings is set by SHC[1:0] as follows: 00 – 8 readings, 01 – 16 readings, 10 – 32 readings, 11 – 64 readings.

SHTH[2:0] sets the X/Y shake threshold that acceleration must exceed to trigger the first shake event. SHTH[2:0] sets the shake threshold for the X, Y, and Z axes to a value between 0.25g (for SHTH[2:0]=000) and 2.0g (for SHTH[2:0]=111); each increment of SHTH[2:0] by 1 LSB increases shake threshold by 0.25g.

SHM is the X/Y shake mode bit. If SHM = 0, then for a shake to be detected, the second shake event must exceed the threshold set by SHTH[2:0] with the opposite sign of the first shake event, within the number of readings set by SHC[1:0]. If SHM = 1, then the second shake event must just have the opposite sign of the first shake event within the number of readings set by SHC[1:0].

0x0D: CONTROL - Operating mode control and full-scale range (read/write)

Table 22: Operating mode control and full-scale range, register 0x0D (read/write)

D7	D6	D5	D4	D3	D2	D1	D0
ST	FSR[1]	FSR[0]	0	-	-	0	PD

PD is the power down bit. Setting PD = 1 places MXC6655XA into a low-power, non-functional power down state.

FSR[1:0] determine the full-scale input acceleration range of MXC6655XA. The following table summarizes the full scale input ranges and output sensitivities for the XOUT, YOUT, and ZOUT acceleration outputs for each setting.

Table 23: Full-scale Range and Sensitivity

FSR[1]	FSR[0]	Range (g)	Sensitivity (LSB/g)
0	0	±2	1024
0	1	±4	512
1	0	±8	256
1	1	Undefined	N/A

ST activates self-test test mode. The recommended method for verifying ST output is as follows:

1. Place the device in Z+1g or Z-1g position. Control the angle error between device XY plane and the horizontal plane smaller than 3 degrees.
2. Write 0x80 into 0x0B to disable temperature compensation.
3. Write 0xC0 in to 0x0D to active self-test and 8g mode. Read XY outputs.
4. Set ST and TC back to 0 to allow normal operation.

0x0F: Who_Am_I - is a read-only register to identify the MXC6655XA.

Table 24: Who_Am_I, register 0x0F

D7	D6	D5	D4	D3	D2	D1	D0
-	-	-	-	0	1	0	1

WAI[3:0] is an 4-bit version code programmed by the factory into non-volatile memory on MXC6655XA.

PACKAGE OUTLINE DRAWING

Unit: mm

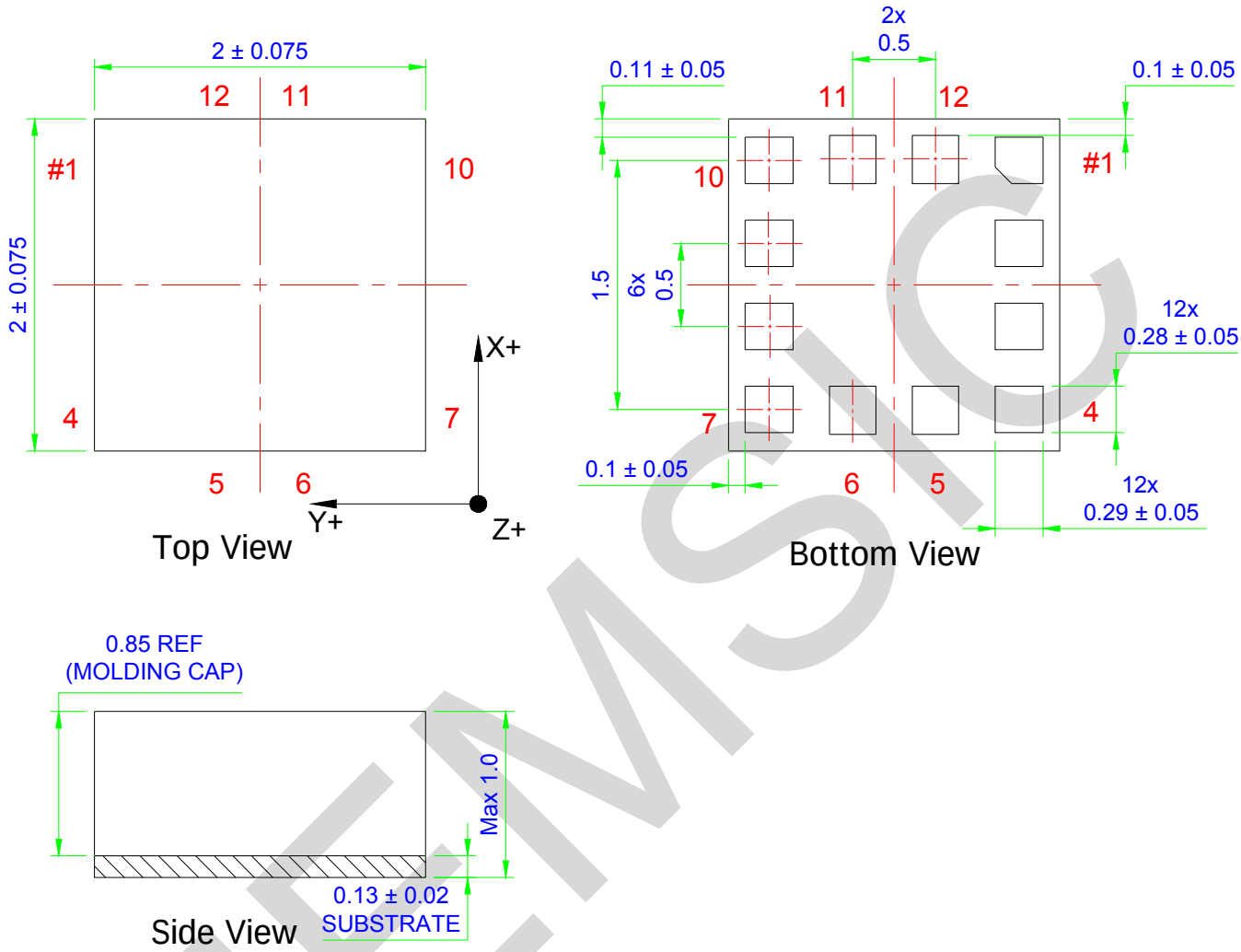

Figure 11: Mechanical package outline dimensions

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